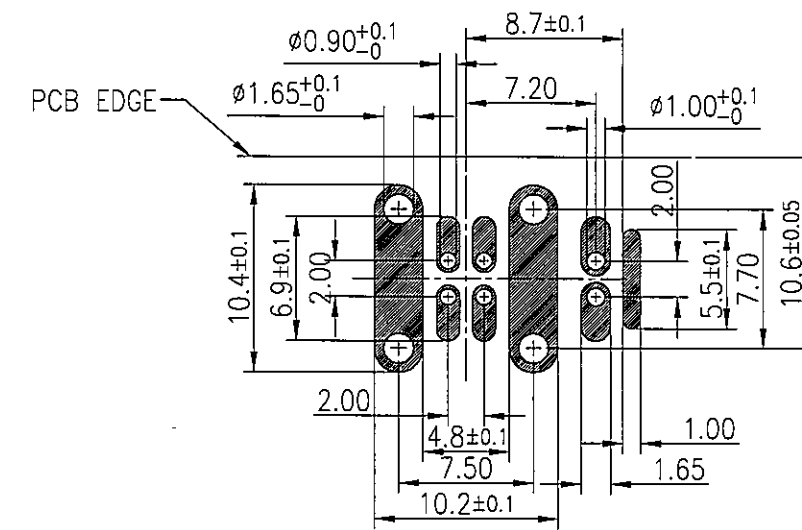
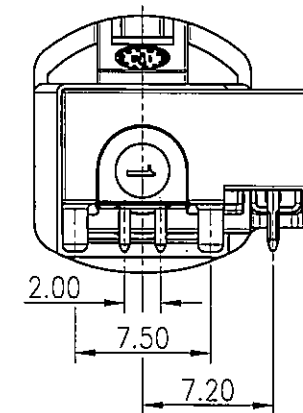
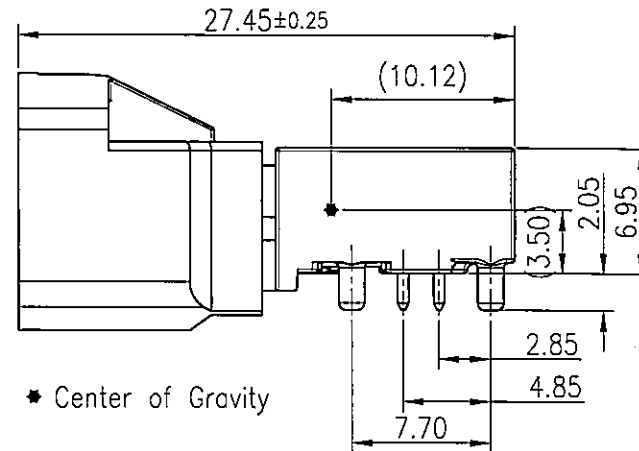
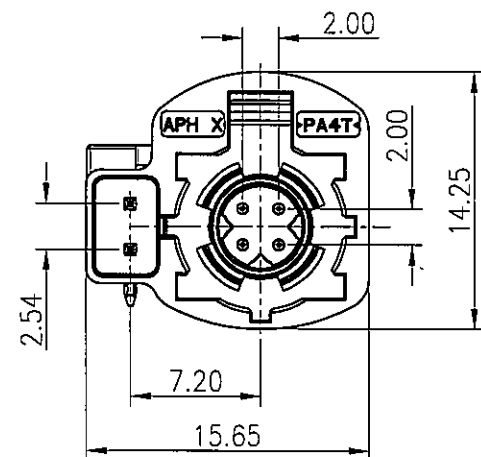
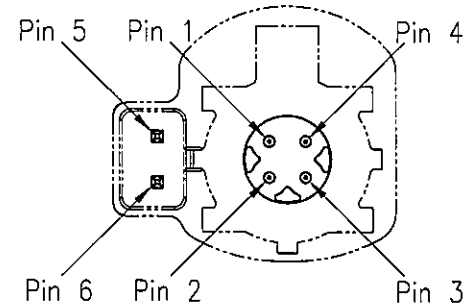


CUSTOMER DRAWING

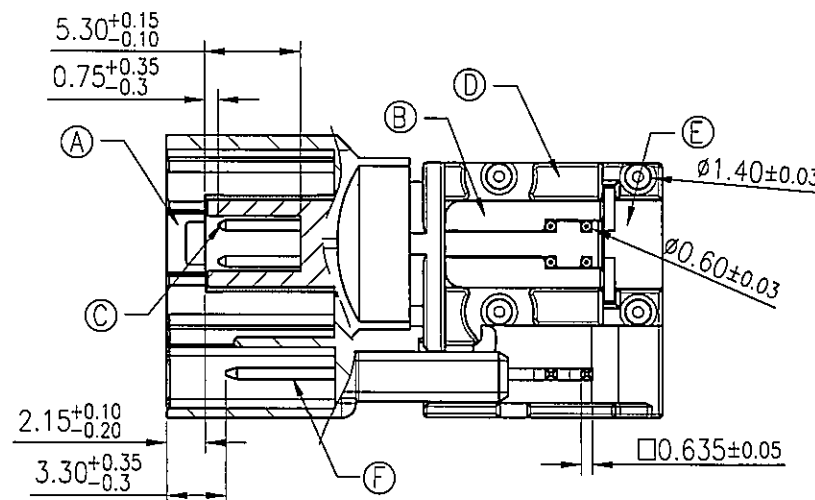
REVISIONS				
SYM	ECN	DESCRIPTION	DATE	APPROVED
5	HK7310	new design	1/25'16	IP



RECOMMENDED PCB LAYOUT TOP VIEW
TOLERANCE:±0.05(PCB THICKNESS=1.6±0.15mm)



PINNING STANDARD



Notes:

1.Material:

- ① Housing: High temperature thermoplastic,color see table 1.
- ② Dielectric: High temperature thermoplastic,color black.
- ③ Center contact: Copper alloy.
- ④ Outer contact : Zinc alloy.
- ⑤ Cover: Zinc alloy.
- ⑥ MQS contact: Copper alloy.

2.Finish:

- ③ Center contact: Gold plated at mating area;
- ④ Outer contact: Tin plated.
- ⑥ MQS contact: Tin plated.

3. RoHs compliant.

4. Order P/N system:

HSD NXRP PCB 7X

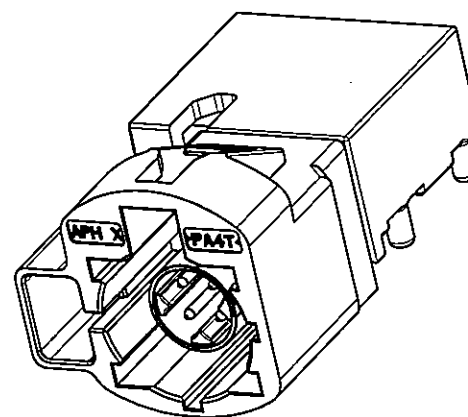
Coding: _____
See table 1

Packing method:

- A- Packing by tape & reel
- B- Packing by tray
- C- Single Packing

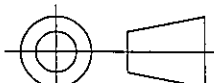
Table 1

Plug	Coding	Color	Ral
	A	Black	9005
	B	White	9001
	C	Blue	5005
	D	Claret	4004
	E	Green	6002
	F	Brown	8011
	Z	Waterblue	5021



3D PROFILE



UNLESS OTHERWISE SPECIFIED TOLERANCES		APPROVAL		DATE		Amphenol	
U.S. METRIC		DRAWN		Kaka Yang 1/25'16			
.X +/-		CHECKED		Wilder 1/28'16			
.XX +/-		CHECKED					
.XXX +/-						TITLE	
FRACTIONS +/-							
ANGLES +/-							
5°							
FOR MATERIALS AND FINISHES SEE NOTES		DRAWING FILE :		HSD + 2MQS R/A PLUG NORTH LOCATION			
		S:\PE Master\DRAWING\HSD\HSDNXRPPCB7X-5.DWG					
REMOVE SHARP EDGES		ANGLE OF PROJECTION					
DIMENSIONS							
U.S. INCHES							
METRIC MM							
		SCALE		1:1		SHEET 1 OF 1	